



# NCE N-Channel Super Trench Power MOSFET



The NCEP6016AS uses Super Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of R<sub>DS(ON)</sub> and Q<sub>g</sub>. This device is ideal for high-frequency switching and synchronous rectification.
General Features

V<sub>DS</sub> =60V,I<sub>D</sub> =16A
R<sub>DS(ON)</sub>=8.2mΩ (typical) @ V<sub>GS</sub>=10V
R<sub>DS(ON)</sub>=9.6mΩ (typical) @ V<sub>GS</sub>=4.5V

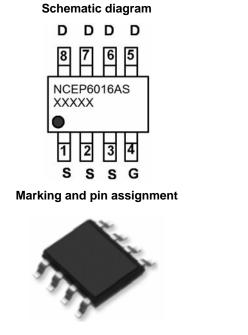
Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
Very low on-resistance R<sub>DS(on)</sub>

- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

## Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!



(2) D

(3) s

SOP-8 top view

## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP6016AS	NCEP6016AS	SOP-8	Ø330mm	12mm	4000 units

## Absolute Maximum Ratings (T<sub>A</sub>=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	16	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	11.3	А
Pulsed Drain Current	I <sub>DM</sub>	64	А
Maximum Power Dissipation	PD	3	W
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	200	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C





# NCEP6016AS

## **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient(	R <sub>0JA</sub>	41.7			°C <b>/W</b>	
Electrical Characteristics (Tc:	=25℃unless of	herwise noted)	·			
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	· · ·		-			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	60		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =60V, $V_{GS}$ =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.2	1.8	2.5	V
Droin Source On State Desistence	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	-	8.2	9.2	mΩ
Drain-Source On-State Resistance		$V_{GS}$ =4.5V, I <sub>D</sub> =10A	-	9.6	11.5	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =10V,I <sub>D</sub> =10A	35	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	<u>)</u>	-	2100	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V, F=1.0MHz	-	359	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHZ	-	12	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	9	-	nS
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =30V,I <sub>D</sub> =10A	-	3	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =4.7 $\Omega$	-	31	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	5	-	nS
Total Gate Charge	Qg	N/ 00)// 40A	-	36.6		nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =30V,I <sub>D</sub> =10A,	-	6.7		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	5.8		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =10A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	16	Α
Reverse Recovery Time	t <sub>rr</sub>	$T_J$ = 25°C, $I_F$ = $I_S$	-	40		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	50		nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse Width ≤ 300 $\mu$ s, Duty Cycle ≤ 2%.

4. Guaranteed by design, not subject to production 5. EAS condition : Tj=25 $^{\circ}$ C,V<sub>DD</sub>=30V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$ 

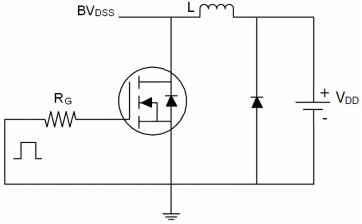


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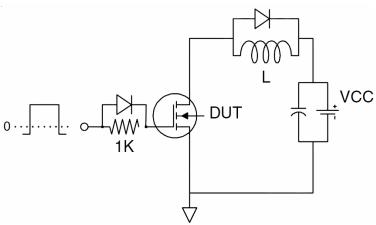




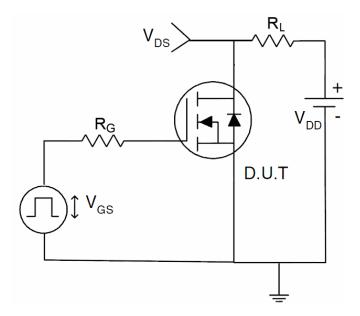
## Test Circuit 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit



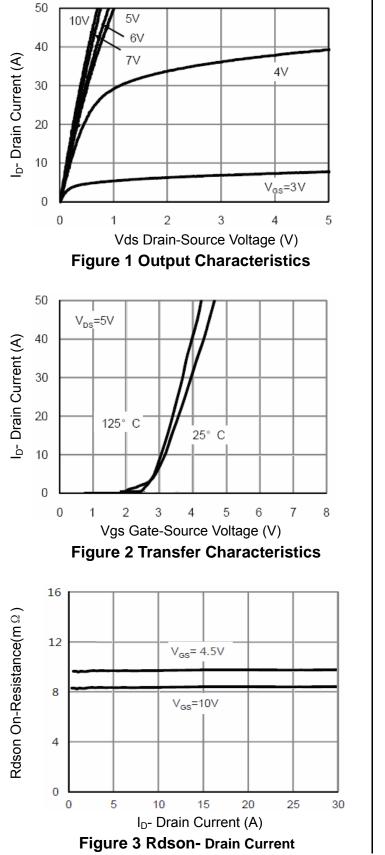
3) Switch Time Test Circuit

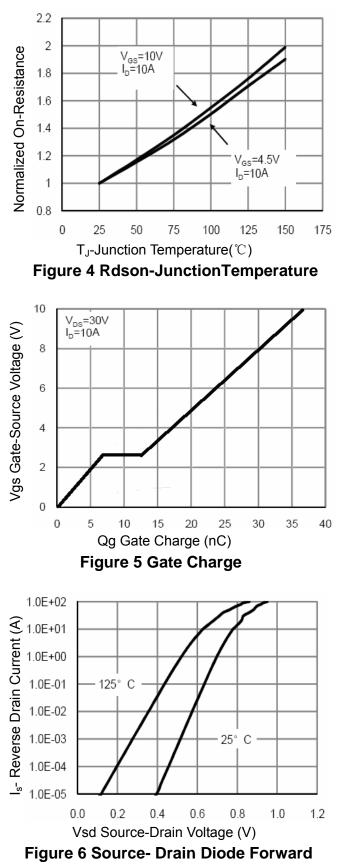














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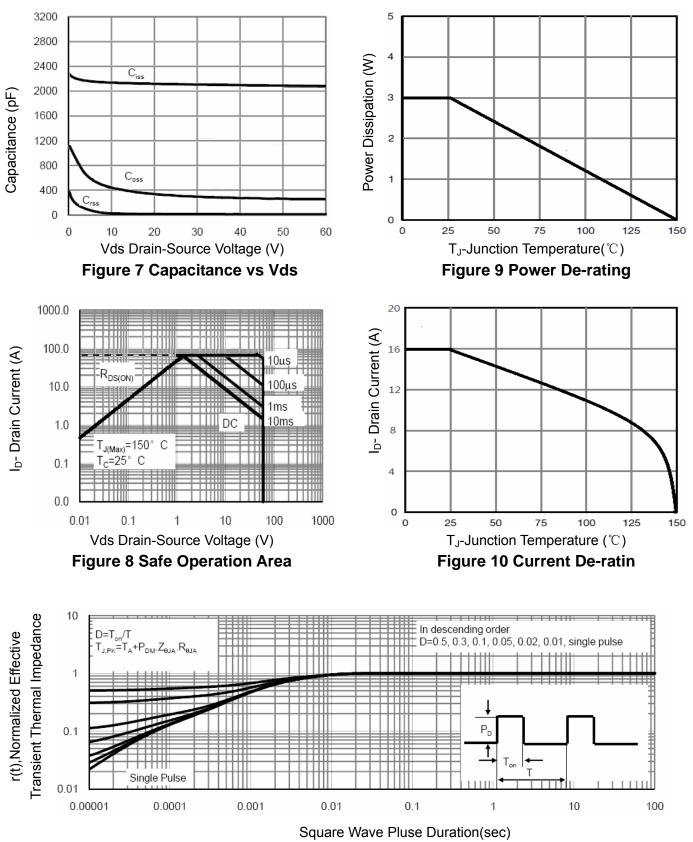


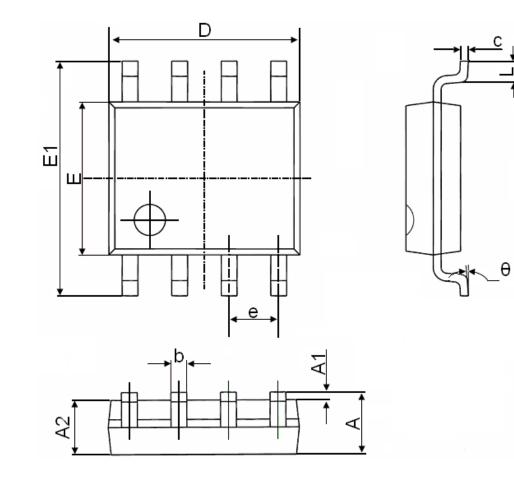
Figure 11 Normalized Maximum Transient Thermal Impedance



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# SOP-8 Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	





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